AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing Of Claims:

- 1-22. (Canceled)
- 23. (New) A rectifier for rectifying an alternating current into a direct current, comprising: a control part including a controller component and control terminals; a power circuit controlled by the control part and including switching elements; and a three-phase generator including a three-phase stator winding, wherein: phases of the stator winding are triggered via the switching elements, all power-conducting components of the power circuit are power MOS
- 24. (New) The rectifier as recited in Claim 23, wherein the power-conducting components are power MOS components that are contacted on both sides.
- 25. (New) The rectifier as recited in Claim 23, further comprising: a cooling device, wherein:

components and are integrated in a stacked construction.

the stacked construction of the power includes a first substrate and a second substrate, between which the power MOS components are placed via contacts on both sides.

- 26. (New) The rectifier as recited in Claim 25, wherein the cooling device is situated on top of the stacked construction.
- 27. (New) The rectifier as recited in Claim 25, wherein the cooling device is situated on the bottom of the stacked construction.
- 28. (New) The rectifier as recited in Claim 23, wherein the power circuit is contacted outward over a surface.

NY01 911467 v1 3

- 29. (New) The rectifier as recited in Claim 28, wherein the power circuit is contacted outward via a heat conducting paste applied over a surface for dissipating heat.
- 30. (New) The rectifier as recited in Claim 24, wherein the power MOS components are contacted on both sides via contact surfaces serving as soldering points/soldering surfaces in the stacked construction.
- 31. (New) The rectifier as recited in Claim 24, wherein the power MOS components are contacted on both sides via contact surfaces serving as conductive adhesive surfaces in the stacked construction.
- 32. (New) The rectifier as recited in Claim 24, further comprising:

a cooling element, wherein the stacked construction of the power circuit includes a pressed screen and a first substrate, between which the power MOS components, contacted on both sides, are placed.

- 33. (New) The rectifier as recited in Claim 23, wherein the stacked construction of the power circuit includes an IMS substrate, to which the power MOS components are connected.
- 34. (New) The rectifier as recited in Claim 23, wherein the control part is designed in a single-chip construction and includes a controller-ASIC component having an integrated driver component.
- 35. (New) The rectifier as recited in Claim 23, wherein the control part is designed in a multi-chip construction having a separate controller-ASIC component and a separate driver component.
- 36. (New) The rectifier as recited in Claim 25, wherein the power circuit contains power terminals as contacts between the first substrate and the second substrate.
- 37. (New) The rectifier as recited in Claim 25, wherein the power circuit includes power terminals that are placed on the first substrate of the stacked construction.

4

- 38. (New) The rectifier as recited in Claim 23, further comprising: an injection molded material in which the power MOS components are encapsulated.
- 39. (New) The rectifier as recited in Claim 25, wherein power terminals of the power circuit extend outside on an exposed, coating-free surface of one of substrate surfaces of the stacked construction.
- 40. (New) The rectifier as recited in Claim 38, wherein the power terminals extend one of outside laterally and in a vertical direction from the power circuit.
- 41. (New) The rectifier as recited in Claim 23, wherein:

 the control part is situated on a surface, made from injection molded material, of
 the power circuit and is connected thereto via the control terminals extending outside in
 a vertical direction.
- 42. (New) The rectifier as recited in Claim 23, wherein the control part includes an application-specific element.
- 43. (New) The rectifier as recited in Claim 25, wherein the stacked construction includes a base plate having metallic fixing elements projecting from sides thereof.
- 44. (New) The rectifier as recited in Claim 25, wherein the control part includes one of a standard-packaged IC and an IC having a wiring, each having second control terminals and to which the control terminals of one of the first substrate and the second substrate are connected.

5